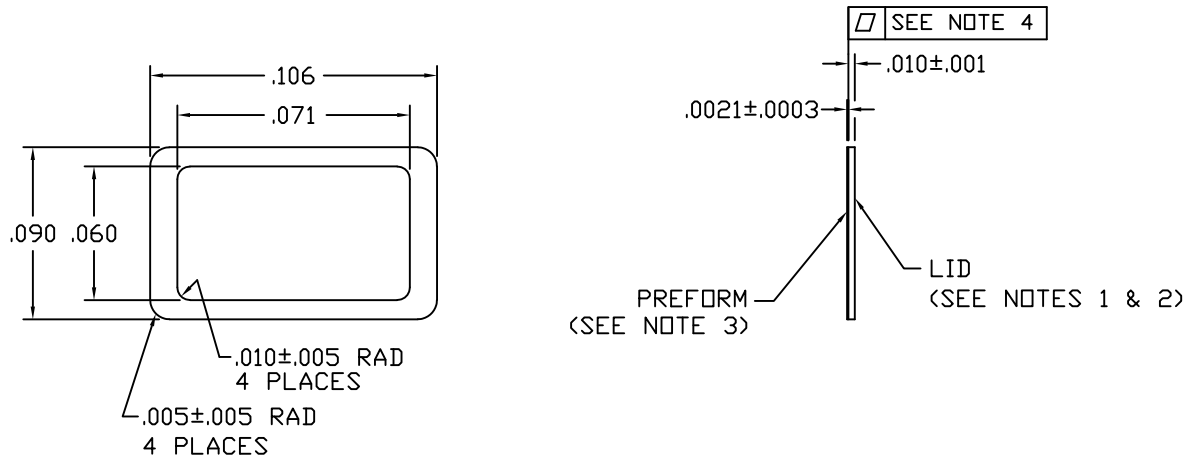


SSM P/N CL100902



NOTES

1. MAT'L : KOVAR OR ALLOY 42
 2. PLATING : 1st LAYER 50/350 MICROINCHES Ni
 2nd LAYER 25 MICROINCHES MIN. Au
 3rd LAYER 50/350 MICROINCHES Ni
 4th LAYER 25 MICROINCHES MIN. Au
- NOTES : TOTAL NICKEL LAYERS SHALL NOT EXCEED 450 MICROINCHES AND THE SUM OF BOTH GOLD LAYERS SHALL BE 50 MICROINCHES MINIMUM.
3. PREFORM - 80% ±1% Au
 20% Sn
 4. FLATNESS : ONE MIL (.001) MAXIMUM PER 1/2" T.I.R
 5. TOLERANCES TO BE (XXX) 3 PLACES ±.003 UNLESS OTHERWISE NOTED

| | | | |
|--|--|-------------------------------|-------------|
| Part Name: CL100902 | | Description: Hi-Rel Combo Lid | |
| Part Number: W1264H | | Mfg: Materion Corporation | Scale 4 = 1 |
| Spectrum Semiconductor Materials, Inc. 155 Nicholson Lane San Jose, CA 95134 PH: (408) 435-5555 Fx: (408)435-8226 | | Approved By: SJO | |
| | | Rev. Date: 10/19/2017 | |

